

Workmanship requirements for soldered electronic assemblies —

Part 3: Through-hole mount assemblies

The European Standard EN 61192-3:2003 has the status of a
British Standard

ICS 31.190

National foreword

This British Standard is the official English language version of EN 61192-3:2003. It is identical with IEC 61192-3:2002.

The UK participation in its preparation was entrusted to Technical Committee EPL/501, Electronic assembly technology, which has the responsibility to:

- aid enquirers to understand the text;
- present to the responsible international/European committee any enquiries on the interpretation, or proposals for change, and keep the UK interests informed;
- monitor related international and European developments and promulgate them in the UK.

A list of organizations represented on this committee can be obtained on request to its secretary.

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Amendments issued since publication

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